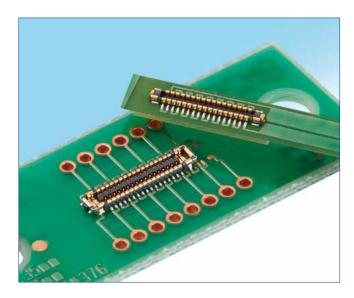


0.35mm pitch, 0.6mm height, Board to Board or Board to FPC Connectors with Rated Current Up to 5A

BM28 Series



Conventional article (P=0.35mm, 20pos.) BM28-10pos. (+2pos. for power) Power lines are concentrated into 2 power contacts

instead of conventional multiple signal contacts.

■Features

1. Rated current 5A

2 Power contacts up to 5A with 0.2A contacts for signal, space-saving connector.

2. Highly reliable contact design

2-point contact design for both power & signal ensures a highly reliable contact

3. Good mating operation

Guide ribs ensure 0.3mm self-alignment. Clear tactile click prevents partial mating, increases mating operability.

4. Supports USB3.1 Gen.2 (10Gbps) transmission Signal connector supports USB3.1 Gen.2 transmission signals.

■Usage

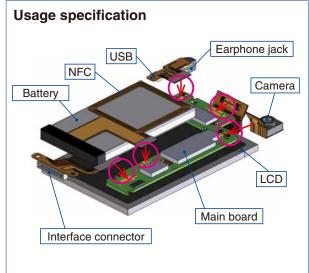
Devices designed to be thinner and smaller, such as mobile phone, wearable device, tablet PC.

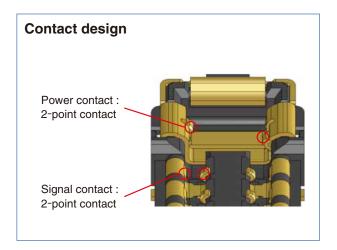
■Environmental

·Halogen-free*

As defined by IEC 61249-2-21 Br: 900ppm max, Cl: 900ppm max

Br+Cl:1500ppm max





■Product Specifications

_							
	Potingo	Rated current	Power contact : 5A Signal contact : 0.2A(Note 1)	Operating temperature range	-40 to 85°C (Note 2)	Storage temperature range	-10 to 60°C (Note 3)
	Ratings	Rated voltage	30V AC/DC	Operating humidity range	20 to 80%	Storage humidity range	40 to 70% (Note 3)

Items	Specifications	Conditions	
1. Contact resistance	Signal contact : $100m\Omega$ max. Power contact : $30m\Omega$ max.	Measured at 20mV AC, 1kHz, and 1mA	
2. Insulation resistance	1000M Ω min.	Measured at 100V DC	
3. Withstanding voltage	No flashover or dielectric breakdown	150V AC for 1 minute	
4. Durability	Contact resistance : Signal contact : $100m\Omega$ max. Power contact : $30m\Omega$ max.	10 mating cycles	
5. Vibration	No electrical discontinuity for more than 1μ s.	Frequency: 10 to 55Hz; half amplitude of 0.75mm, 10 cycles in each of 3 axis directions for 5 minutes/cycle	
6. Shock resistance	No electrical discontinuity of $1\mu s$ or more.	Acceleration: 450m/s², duration: 11ms, 3-axis has sine wave in both directions, 3 cycles for each	
7. Humidity	Contact resistance : Signal contact : $100m\Omega$ max. Power contact : $30m\Omega$ max. Insulation resistance : $100M\Omega$ min.	96 hours at a temperature of 40 ±2°C and a humidity range from 90 to 95%	
8. Temperature cycle	Contact resistance : Signal contact : $100m\Omega$ max. Power contact : $30m\Omega$ max. Insulation resistance : $100M\Omega$ min.	-55±3℃: 30 minutes → 85±2℃: 30 minutes, 5 cycles	
9. Solder heat resistance	No dissolution or melting of the resin that will affect the performance.	Reflow: with recommended temperature profile; Hand soldering at soldering iron temperature of 350°C for 3 seconds max.	

Note 1: The total current capacity for connectors with 50 or more signal contacts is 10A for all contacts. (Signal contact only)

Note 2: Includes temperature rise caused by current flow.

Note 3: Storage refers to long-term-storage of unused items before they are mounted on the PCB.

Operating temperature / humidity range applies to the state of temporary storage such as non-powered after mounting on the PCB, and during transportation, etc.

■Materials / Finish

Product	Part	Materials	Finish	UL Regulation
	Insulator	LCP	Black	UL94V-0
Receptacle Header	Signal contact	Copper alloy	Gold plated	
	Power contact	Copper alloy	Gold plated	*********

■Product Number Structure

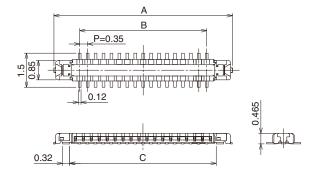
Refer to the chart below when determining the product specifications from the product number. Please select from the product numbers listed in this catalog when placing orders.

●Receptacle / Header

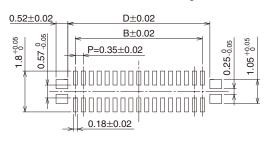
Series Name : BM	6 Number of Power Contacts : 2
2 Series No. : 28	7 Contact Pitch : 0.35mm
3 Stacking height: 0.6mm	Termination type
4 Number of Signal Contacts: 10, 16, 20, 24, 30, 34, 40	V : Straight SMT
Connector type DS : Receptacle DP : Header	 Gold plated specification and packaging status (51): Gold plate thickness 0.05

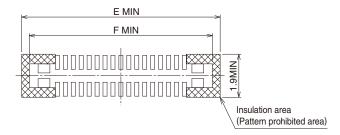
■Header



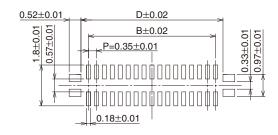


●Recommended PCB layout





●Recommended metal mask dimensions (mask thickness : 80µm)



Unit: mm

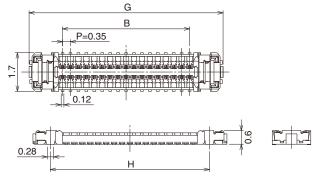
Part No.	HRS No.	No. of contacts	Α	В	С	D	Е	F
BM28B0.6-6DP/2-0.35V(51)	Under development	6	2.97	0.70	1.56	1.36	3.85	3.17
BM28B0.6-10DP/2-0.35V(51)	673-5043-0 51	10	3.67	1.40	2.26	2.06	4.55	3.87
BM28B0.6-16DP/2-0.35V(51)	673-5066-0 51	16	4.72	2.45	3.31	3.11	5.60	4.92
BM28B0.6-20DP/2-0.35V(51)	673-5039-0 51	20	5.42	3.15	4.01	3.81	6.30	5.62
BM28B0.6-24DP/2-0.35V(51)	673-5024-0 51	24	6.12	3.85	4.71	4.51	7.00	6.32
BM28B0.6-30DP/2-0.35V(51)	673-5020-0 51	30	7.17	4.90	5.76	5.56	8.05	7.37
BM28B0.6-34DP/2-0.35V(51)	673-5064-0 51	34	7.87	5.60	6.46	6.26	8.75	8.07
BM28B0.6-40DP/2-0.35V(51)	673-5018-0 51	40	8.92	6.65	7.51	7.31	9.80	9.12
BM28B0.6-44DP/2-0.35V(51)	Under development	44	9.62	7.35	8.21	8.01	10.50	9.82
BM28B0.6-50DP/2-0.35V(51)	Under development	50	10.67	8.40	9.26	9.06	11.55	10.87
BM28B0.6-60DP/2-0.35V(51)	Under development	60	12.42	10.15	11.01	10.81	13.30	12.62

Note 1: Please place orders in full reel quantities.

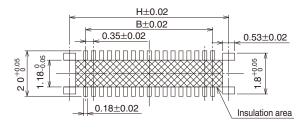
Note 2: This connector has no polarity.

■Receptacle

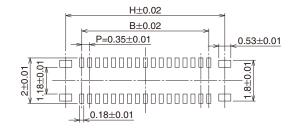




●Recommended PCB layout



●Recommended metal mask dimensions (mask thickness : 80µm)



Unit: mm

Part No.	HRS No.	No. of contacts	В	G	Н
BM28B0.6-6DS/2-0.35V(51)	Under development	6	0.70	3.65	2.11
BM28B0.6-10DS/2-0.35V(51)	673-5044-0 51	10	1.40	4.35	2.81
BM28B0.6-16DS/2-0.35V(51)	673-5067-0 51	16	2.45	5.40	3.86
BM28B0.6-20DS/2-0.35V(51)	673-5040-0 51	20	3.15	6.10	4.56
BM28B0.6-24DS/2-0.35V(51)	673-5025-0 51	24	3.85	6.80	5.26
BM28B0.6-30DS/2-0.35V(51)	673-5021-0 51	30	4.90	7.85	6.31
BM28B0.6-34DS/2-0.35V(51)	673-5065-0 51	34	5.60	8.55	7.01
BM28B0.6-40DS/2-0.35V(51)	673-5019-0 51	40	6.65	9.60	8.06
BM28B0.6-44DS/2-0.35V(51)	Under development	44	7.35	10.30	8.76
BM28B0.6-50DS/2-0.35V(51)	Under development	50	8.40	11.35	9.81
BM28B0.6-60DS/2-0.35V(51)	Under development	60	10.15	13.10	11.56

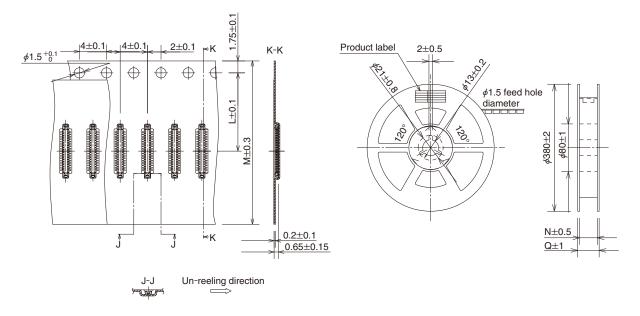
Note 1: Please place orders in full reel quantities.

Note 2: This connector has no polarity.

● Embossed Tape Dimensions (IEC 60286-3, with JIS C 0806)

● Header

Reel dimensions



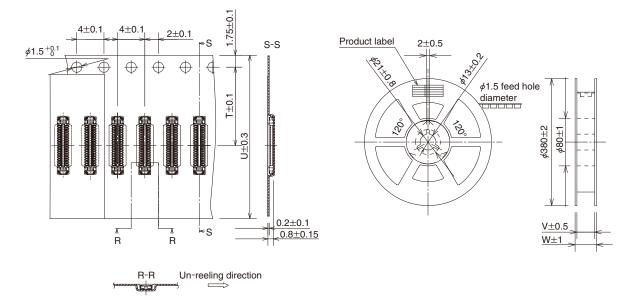
Unit: mm

					•
Part No.	No. of contacts	L	М	N	Q
BM28B0.6-6DP/2-0.35V(51)	6	5.5	12	13.5	17.5
BM28B0.6-10DP/2-0.35V(51)	10	5.5	12	13.5	17.5
BM28B0.6-16DP/2-0.35V(51)	16	7.5	16	17.5	21.5
BM28B0.6-20DP/2-0.35V(51)	20	7.5	16	17.5	21.5
BM28B0.6-24DP/2-0.35V(51)	24	7.5	16	17.5	21.5
BM28B0.6-30DP/2-0.35V(51)	30	7.5	16	17.5	21.5
BM28B0.6-34DP/2-0.35V(51)	34	11.5	24	25.4	29.4
BM28B0.6-40DP/2-0.35V(51)	40	11.5	24	25.4	29.4
BM28B0.6-44DP/2-0.35V(51)	44	11.5	24	25.4	29.4
BM28B0.6-50DP/2-0.35V(51)	50	11.5	24	25.4	29.4
BM28B0.6-60DP/2-0.35V(51)	60	11.5	24	25.4	29.4

● Embossed Tape Dimensions (IEC 60286-3, with JIS C 0806)

Receptacle

●Reel dimensions



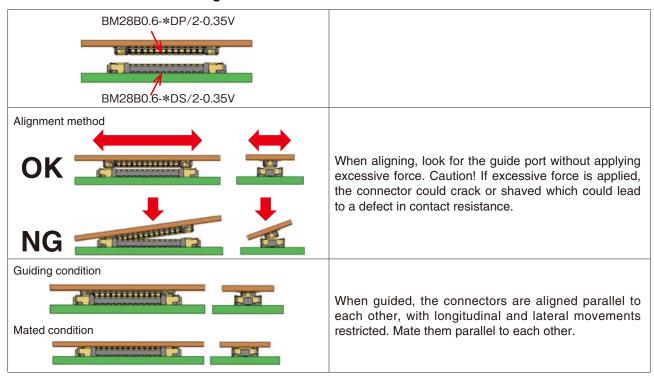
Unit: mm

					•
Part No.	No. of contacts	Т	U	V	W
BM28B0.6-6DS/2-0.35V(51)	6	5.5	12	13.5	17.5
BM28B0.6-10DS/2-0.35V(51)	10	7.5	16	17.5	21.5
BM28B0.6-16DS/2-0.35V(51)	16	7.5	16	17.5	21.5
BM28B0.6-20DS/2-0.35V(51)	20	7.5	16	17.5	21.5
BM28B0.6-24DS/2-0.35V(51)	24	7.5	16	17.5	21.5
BM28B0.6-30DS/2-0.35V(51)	30	11.5	24	25.4	29.4
BM28B0.6-34DS/2-0.35V(51)	34	11.5	24	25.4	29.4
BM28B0.6-40DS/2-0.35V(51)	40	11.5	24	25.4	29.4
BM28B0.6-44DS/2-0.35V(51)	44	11.5	24	25.4	29.4
BM28B0.6-50DS/2-0.35V(51)	50	11.5	24	25.4	29.4
BM28B0.6-60DS/2-0.35V(51)	60	11.5	24	25.4	29.4

♦ Precautions

Recommended solder temperature profile			7	AX 10sec			
temperature prome	250	MAX 250°C					
	250						
		220	°c/	\			
	200		/				
	le (Ĉ	180℃	/				
	e 150		i i				
	Temperature (°C)						
	100			ļ 			
	50 –						
	Room		Within 60)!)!			
	temperature	90 to 120 sec	seconds	¥			
	0	Preheating	Soldering time	9			
	Heating time (sec)						
	[Conditions]						
	Peak temperate Heat section						
	3. Preheat section	: 220℃ min., within 1 : 150 to 180℃, 90 to					
	4. Number of refle	ow cycles : Maximum of 2 cycl	les				
	Note 1 : The temperature area of the conn		perature of th	e PCB in the			
Recommended manual soldering conditions	Soldering iron temperature : 340 \pm 10°C ; Soldering time : within 3 seconds						
Recommended stencil thickness and open area ratio to PCB pattern area	Thickness: 0.08mm Aperture ratio: 100% on the DS side; 100% for signal contact, and 80% for power contact on the DP side						
4. Board warpage	A maximum of 0.02mm at the center of the connector relative to each end of the connector.						
5. Cleaning conditions	Cleaning is not recom performance before using (Cleaning may impair tenvironmental factors)						
6. Precautions	the PCB. This could cau	rhen mating/unmating the case damage or deformation	of the contact				
		CB only with the connecto					
	●Care should be taken the	ans such as bolts, screws nat excessive prying mati dering, please do not app	ng/unmating c	•			
	This product may have slight color differences due to production lot variability, but this does not the performance.						
	 Please refer to the next page for precautions regarding mating/unmating. Because the product can disengage if dropped (or other impact), and by FPC 						
	routing, it is advised to secure the mated connectors to the board with hous						
	cushioning materials. Caution! Do not use the connector in non-recommended conditions (i.e., rated current, rated voltage, PCB design and operating environment, etc.). Such usage						
	could lead to material of	outgassing, ignition, or sho	ort-circuit, etc.	_			
	cautions, and connecte	ons and the guidelines for treatment.	o board patte	un ensions, board			
	Pleasae contact Hiros	e if using the connector ications and the guideline					

•Handle with care when mating a connector



•Handle with care when un-mating connectors

ОК		Un-mate connectors parallel to each other.
ОК	Pitch direction	If the connector cannot be un-mated parallel it can be removed diagonally from the pitch direction, as shown in the Figure. However, the connector can be broken if the FPC is not rigid. Please confirm rigidity of the FPC at the time of trial production.
NG	Corner direction	Do not pull from the corner, If it is pulled from the corner as shown in the left Figure, the contact and connector could be damaged.
		Please provide a reinforcing plate for the FPC. If the rigidity of the FPC is not sufficient, the connector may break as shown in the left Figure. Please check the action of the FPC to be used repeatedly. A reinforcing plate of 0.3mm or thicker made of glass epoxy material is recommended, or 0.2mm or thicker stainless steel.



HIROSE ELECTRIC CO.,LTD.

2-6-3,Nakagawa Chuoh,Tsuzuki-Ku,Yokohama-Shi 224-8540,JAPAN TEL: +81-45-620-3526 Fax: +81-45-591-3726 http://www.hirose.com

http://www.hirose-connectors.com